



#### 100V N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> T <sub>C</sub> = +25°C
	13.5mΩ @ $V_{GS}$ = 10 $V$	42A
100V	18mΩ @ V <sub>GS</sub> = 6.0V	36A
	23.5mΩ @ V <sub>GS</sub> = 4.5V	32A

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

- Synchronous rectifiers
- Backlighting
- Power-management functions
- DC-DC converters

#### **Features and Benefits**

- Low Rds(ON) Ensures On-State Losses Are Minimized
- Excellent Q<sub>gd x</sub> R<sub>DS</sub> (ON) Product (FOM)
- Advanced Technology for DC/DC Converters
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of The Board Area Occupied by SO-8 Enabling Smaller End Product
- 100% UIS (Avalanche) Rated
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

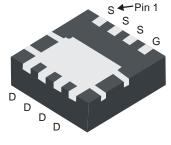
https://www.diodes.com/products/automotive/automotive-products/

 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

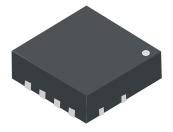
https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

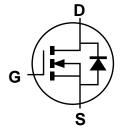
- Package: PowerDI<sup>®</sup>3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 <sup>®</sup>
- Weight: 0.034 grams (Approximate)



**Bottom View** 



Top View



**Equivalent Circuit** 

## **Ordering Information** (Note 4)

Part Number	Package	Packing			
Fait Nullibei	Fackage	Qty.	Carrier		
DMT10H015LFG-7	PowerDI3333-8	2,000	Tape & Reel		
DMT10H015LFG-13	PowerDI3333-8	3,000	Tape & Reel		

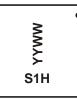
Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



## **Marking Information**

Site1:



S1H = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 23 = 2023) WW = Week Code (01 to 53)

Site2:



S1H = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 3 = 2023) W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

#### Date Code Key

Year	2015	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	5	-	3	4	5	6	7	8	9	0	1	2

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	X	Υ	Z

#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		VDSS	100	V
Gate-Source Voltage		Vgss	±20	V
Continuous Drain Current (Note 5) $V_{GS} = 10V$ $T_{A} = +25^{\circ}C$ $T_{A} = +70^{\circ}C$		I <sub>D</sub>	10 8.0	А
Continuous Drain Current (Note 6) Vgs = 10V	lo	42 26	А	
Maximum Continuous Body Diode Forward Current (Note 5)		Is	1.5	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	75	Α	
Avalanche Current (L = 3mH)	las	7.5	Α	
Avalanche Energy (L = 3mH)		Eas	85	mJ

### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	$P_{D}$	2.0	W
Thermal Resistance, Junction to Ambient (Note 5)	Rеја	61	°C/W	
Total Power Dissipation (Note 6)	P <sub>D</sub>	35	W	
Thermal Resistance, Junction to Case (Note 6)	Rелс	3.5	°C/W	
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

<sup>6.</sup> Thermal resistance from junction to soldering point (on the exposed drain pad).



# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			•		•	•
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	100			V	$V_{GS} = 0V$ , $I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS	_		1	μΑ	V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.4	2.0	3.5	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
			10.8	13.5		$V_{GS} = 10V, I_D = 20A$
Static Drain-Source On-Resistance	RDS(ON)	_	13.3	18	mΩ	$V_{GS} = 6.0V, I_{D} = 20A$
		_	17.9	23.5		$V_{GS} = 4.5V, I_D = 20A$
Diode Forward Voltage	$V_{SD}$	_	0.9	1.3	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 20A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		1,871			., 50,4,74
Output Capacitance	Coss	_	261	_	pF	$V_{DS} = 50V$ , $V_{GS} = 0V$ f = 1MHz
Reverse Transfer Capacitance	Crss	_	6.9	_		1 = 11011 12
Gate Resistance	Rg	_	0.75	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge	Qg	_	33.3	_		
Gate-Source Charge	Qgs	_	6.9	_	nC	$V_{DD} = 50V, I_D = 10A,$
Gate-Drain Charge	Qgd	_	5.1			Vgs = 10V
Turn-On Delay Time	t <sub>D(ON)</sub>	_	6.5	_		
Turn-On Rise Time	tR	_	7.0			$V_{DD} = 50V, V_{GS} = 10V,$
Turn-Off Delay Time	tD(OFF)	_	19.7	_	ns	$I_D = 10A$ , $R_G = 6\Omega$
Turn-Off Fall Time	tr	_	8.1	_		
Reverse Recovery Time	trr	_	37.9	_	ns	1 400 41/44 4000/
Reverse Recovery Charge	Q <sub>RR</sub>	_	51.9	_	nC	-I <sub>F</sub> = 10A, di/dt = 100A/μs

7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing. Notes:



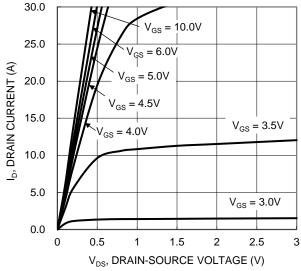


Figure 1. Typical Output Characteristic

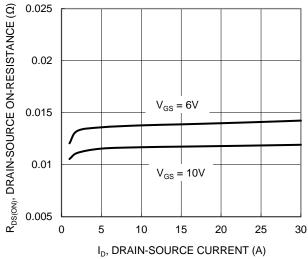


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

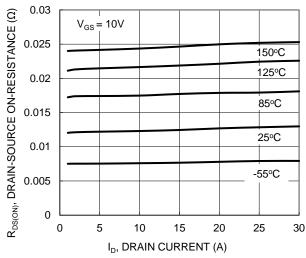


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

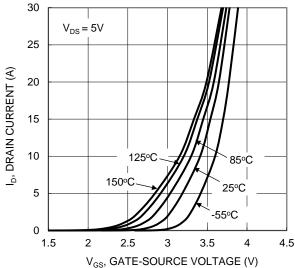


Figure 2. Typical Transfer Characteristic

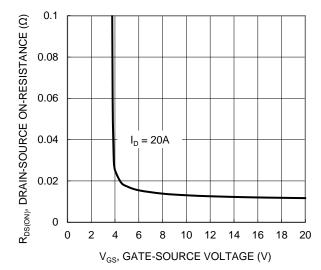


Figure 4. Typical Transfer Characteristic

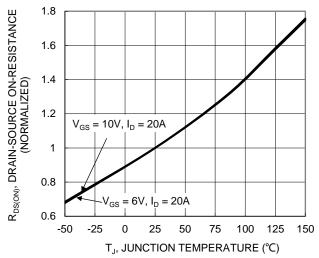


Figure 6. On-Resistance Variation with Junction Temperature





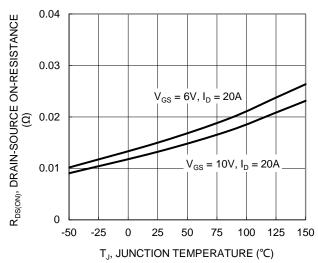


Figure 7. On-Resistance Variation with Junction Temperature

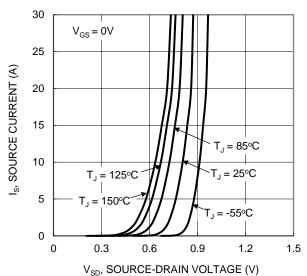


Figure 9. Diode Forward Voltage vs. Current

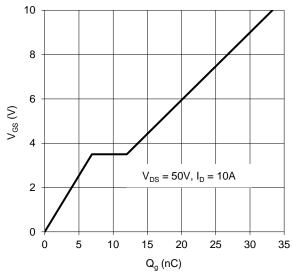


Figure 11. Gate Charge

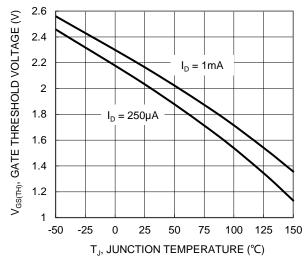
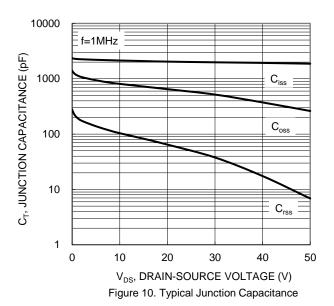


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 R<sub>DS(ON)</sub> Limited =1ms 100 ID, DRAIN CURRENT (A) 10 0.1 Single Pulse 0.01 **DUT on 1\*MRP Board** DĆ  $V_{GS} = 10V$ 0.001 1 10 100 1000 0.01 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation Area



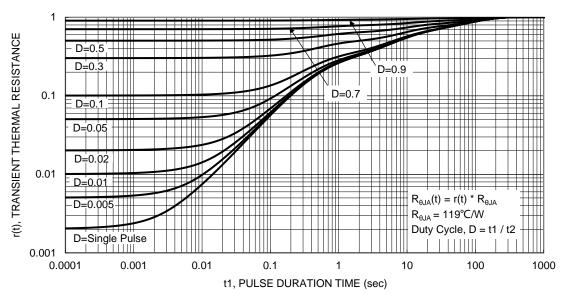


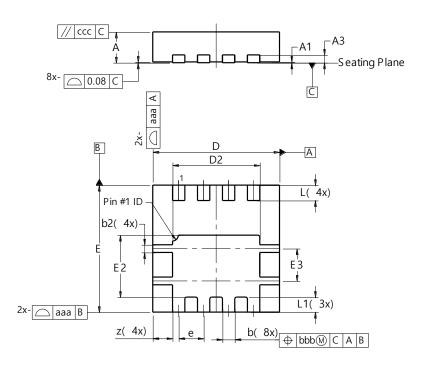
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI3333-8

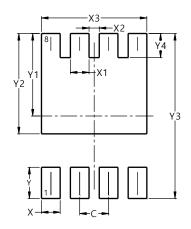


	PowerDI3333-8							
Dim	Min	Тур						
Α	0.75	0.85	0.80					
A1	0.00	0.05	0.02					
A3	1	-	0.203					
b	0.27	0.37	0.32					
b2	-	_	0.20					
D	3.25	3.35	3.30					
D2	2.22	2.32	2.27					
Е	3.25	3.35	3.30					
E2	1.56	1.66	1.61					
E3	0.79	0.89	0.84					
е	1	-	0.65					
L	0.35	0.45	0.40					
L1	_	_	0.39					
Z	_	_	0.515					
aaa	0.25							
bbb		0.10	•					
CCC	0.10							
All [	Dimens	sions ir	n mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
Χ	0.420
X1	0.420
X2	0.230
Х3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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